



# Li98 Thermal Tape

REACH Compliant    RoHS Compliant

## Features

- Good adhesion
- Great reliability
- Cost effective with great performance
- Easy to assemble
- Customization services

## Application:

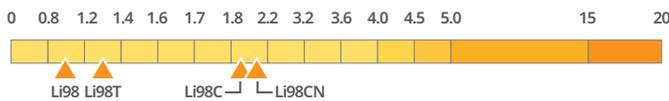
Electronic Components - 5G, Aerospace, AI, AIoT, AR/VR/MR/XR, Automotive, Consumer Devices, Datacom, Electric Vehicle, Electronic Products, Energy Storage, Industrial, Lighting Equipment, Medical, Military, Netcom, Panel, Power Electronics, Robot, Servers, Smart Home, Telecom, etc.

## Storage:

T-Global guarantees a 6-month shelf life at maximum continuous storage. Storage temperature should be under 25°C to maintain controlled adhesion to the liner.

## Properties

**Thermal Conductivity : 1(Li98) / 1.3(Li98T) / 1.9(Li98C) / 2.1(Li98CN) W/mK**



Properties	Unit	Li98		Li98T	Li98C		Li98CN	Tolerance	Test Method
Thermal Conductivity	W/m•K	1	1	1.3	1.9	1.9	2.1	±10%	ASTM D5470 Modified
Thickness	mm	0.15	0.25	0.11	0.15	0.25	0.18	-	ASTM D374
Color		White						-	-
Reinforcement Carrier	-	Fiberglass mesh		PET	Fiberglass mesh		-	-	-
Operating Temperature	° C	-30~+120		-60~+120	-30~+120		-	-	
Short Time Use Temperature (30sec)	° C	200						-	-
Density	g/cm <sup>3</sup>	1.85		1.6	1.8	1.8	1.8	±5%	ASTM D792
Tensile Strength	psi	200	400	400	200	400	-	-	ASTM D412
Glass Transition Temperature	° C	-30	-30	-	-27	-27	-30	-	-
Initial Tack	cm	10	8	10	14	12	15	-	PSTC-6
Lap Shear Strength	N/cm <sup>2</sup>	61		60	55	50	55	-	ASTM D1002
Die Shear Strength@25° C	N/cm <sup>2</sup>	120		105	109	100	100	-	-
Die Shear Strength@80° C	N/cm <sup>2</sup>	69		60	68	68	55	-	-
Holding Power 1000g@25° C using 1 in <sup>2</sup>	min	>10000						-	PSTC-7
Holding Power 1000g@80° C using 1 in <sup>2</sup>	min	>10000						-	PSTC-7
90° Peeling Strength (Aluminum)	N/in	>10	>12	>12	>6	>8	>8	-	ASTM D3330
Dielectric Breakdown Voltage (AC)	KV	≥2	≥3.1	≥4.1	≥2	≥3.1	≥5.1	-	ASTM D149
Dielectric Breakdown Voltage (DC)	KV	≥3.1	≥4.1	≥5.1	≥3.1	≥4.1	≥6.1	-	ASTM D149
Thermal Impedance@10psi	° C*in <sup>2</sup> /W	0.93	1.26	0.63	0.64	0.89	0.73	-	ASTM D5470 Modified
Thermal Impedance@30psi	° C*in <sup>2</sup> /W	0.76	1.05	0.60	0.60	0.85	0.68	-	ASTM D5470 Modified
Thermal Impedance@50psi	° C*in <sup>2</sup> /W	0.61	1.06	0.59	0.53	0.87	0.66	-	ASTM D5470 Modified

※Die-cut for different shapes

※Roll type available

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